



Surface Mount Ultrafast Rectifier



DO-214AC (SMA)

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds AC/AC and DC/DC converters in high temperature conditions for both consumer applications.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

| PRIMARY CHARACTERISTICS | |
|-------------------------|---------------------|
| $I_{F(AV)}$ | 1.0 A |
| V_{RRM} | 100 V, 150 V, 200 V |
| I_{FSM} | 30 A |
| t_{rr} | 25 ns |
| V_F at $I_F = 1.0$ A | 0.76 V |
| T_J max. | 175 °C |

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | | | |
|--|----------------|---------------|------|------|------|
| PARAMETER | SYMBOL | UH1B | UH1C | UH1D | UNIT |
| Device marking code | | HB | HC | HD | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 100 | 150 | 200 | V |
| Maximum average forward rectified current (fig. 1) | $I_{F(AV)}$ | 1.0 | | | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 30 | | | A |
| Operating junction and storage temperature range | T_J, T_{STG} | - 55 to + 175 | | | °C |

UH1B, UH1C, UH1D

Vishay General Semiconductor



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|---|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 0.6 A | T _A = 25 °C | V _F ⁽¹⁾ | 0.90 | - | V |
| | I _F = 1.0 A | | | 0.96 | 1.05 | |
| | I _F = 0.6 A | T _A = 125 °C | | 0.70 | - | |
| | I _F = 1.0 A | | | 0.76 | 0.90 | |
| Reverse current | Rated V _R | T _A = 25 °C | I _R ⁽²⁾ | - | 1.0 | μA |
| | | T _A = 125 °C | | 7.5 | 25 | |
| Maximum reverse recovery time | I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A | T _A = 25 °C | t _{rr} | 13 | 25 | ns |
| Typical reverse recovery time | I _F = 1.0 A, di/dt = 50 A/μs, V _R = 30 V, I _{rr} = 0.1 I _{RM} | | | 21 | 30 | |
| Typical softness factor (t _b /t _a) | I _F = 1.0 A, di/dt = 200 A/μs, V _R = 200 V | T _A = 125 °C | S | 0.8 | - | - |
| Typical reverse recovery current | | | I _{RM} | 2.7 | 4.0 | A |
| Typical stored charge | | | Q _{rr} | 35 | - | nC |
| Typical junction capacitance | | | C _J | 17 | - | pF |
| Typical junction capacitance | 4.0 V, 1 MHz | | | | | |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | |
|---|---------------------------------|------|------|------|------|
| PARAMETER | SYMBOL | UH1B | UH1C | UH1D | UNIT |
| Typical thermal resistance | R _{θJA} ⁽¹⁾ | 120 | | | °C/W |
| | R _{θJM} ⁽¹⁾ | 20 | | | |

Note

- (1) Free air, mounted on recommended copper pad area. Thermal resistance R_{θJA} - junction to ambient, R_{θJM} - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| UH1D-M3/61T | 0.064 | 61T | 1800 | 7" diameter plastic tape and reel |
| UH1D-M3/5AT | 0.064 | 5AT | 7500 | 13" diameter plastic tape and reel |

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

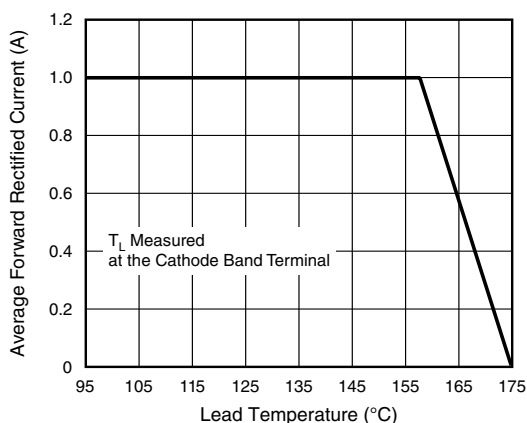


Fig. 1 - Maximum Forward Current Derating Curve

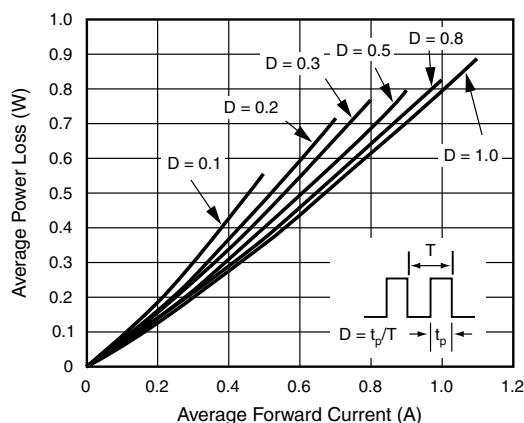


Fig. 2 - Forward Power Loss Characteristics

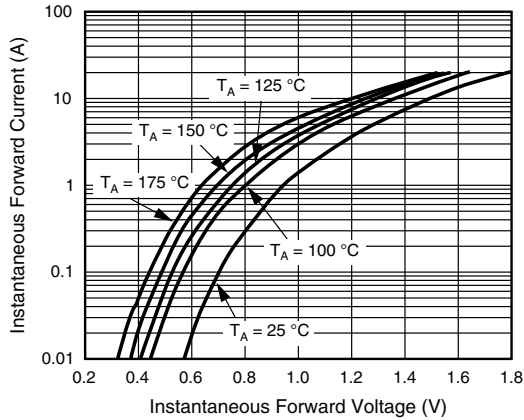


Fig. 3 - Typical Instantaneous Forward Characteristics

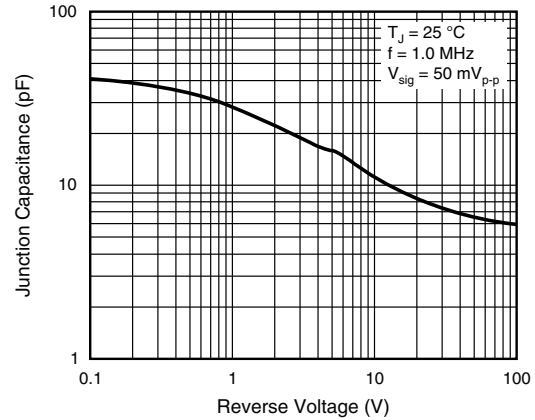


Fig. 5 - Typical Junction Capacitance

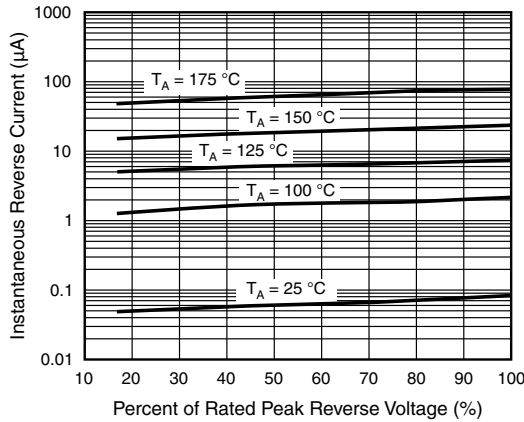


Fig. 4 - Typical Reverse Characteristics

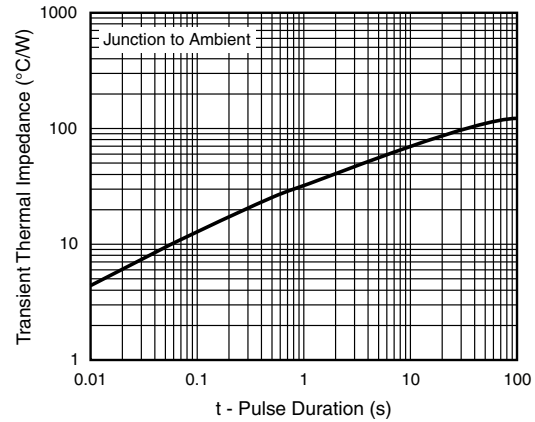
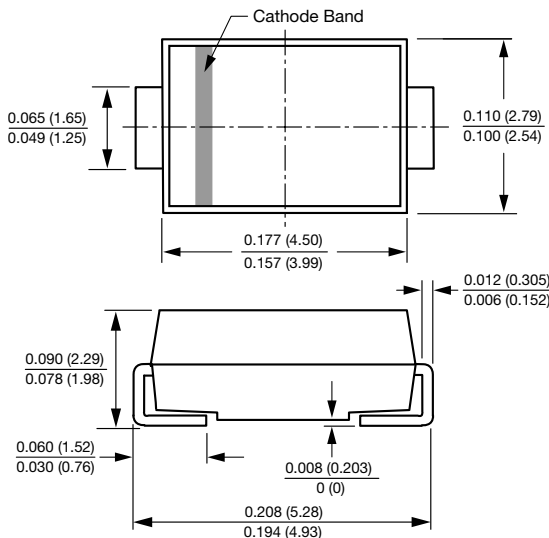


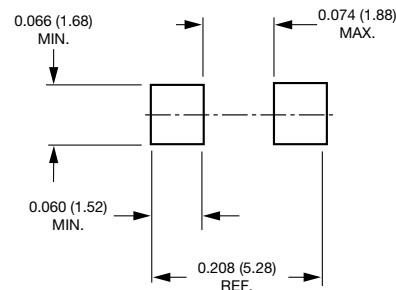
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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